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# 2SK2912(L), 2SK2912(S)

Silicon N Channel MOS FET  
High Speed Power Switching

## HITACHI

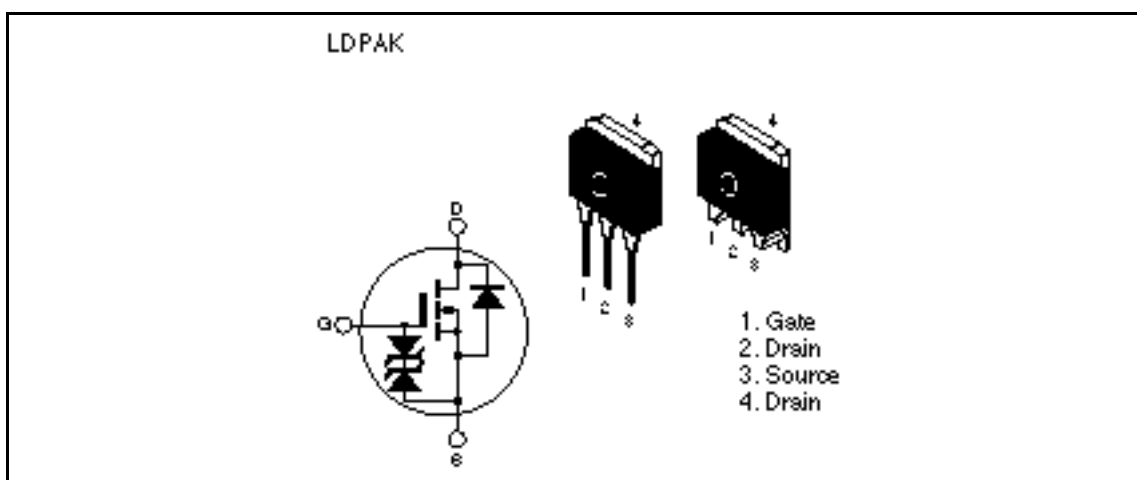
ADE-208-495  
1st. Edition

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### Features

- Low on-resistance  
 $R_{DS} = 15 \text{ m}\Omega$  typ.
- High speed switching
- 4V gate drive device can be driven from 5V source

### Outline



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## 2SK2912(L), 2SK2912(S)

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### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	60	V
Gate to source voltage	$V_{GSS}$	$\pm 20$	V
Drain current	$I_D$	40	A
Drain peak current	$I_{D(pulse)}^{*1}$	160	A
Body to drain diode reverse drain current	$I_{DR}$	40	A
Avalanche current	$I_{AP}^{*3}$	40	A
Avalanche Energy	$E_{AR}^{*3}$	137	mJ
Channel dissipation	$P_{ch}^{*2}$	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW 10μs, duty cycle 1 %

2. Value at Tc = 25°C

3. Value at Tch = 25°C, Rg 50

## 2SK2912(L), 2SK2912(S)

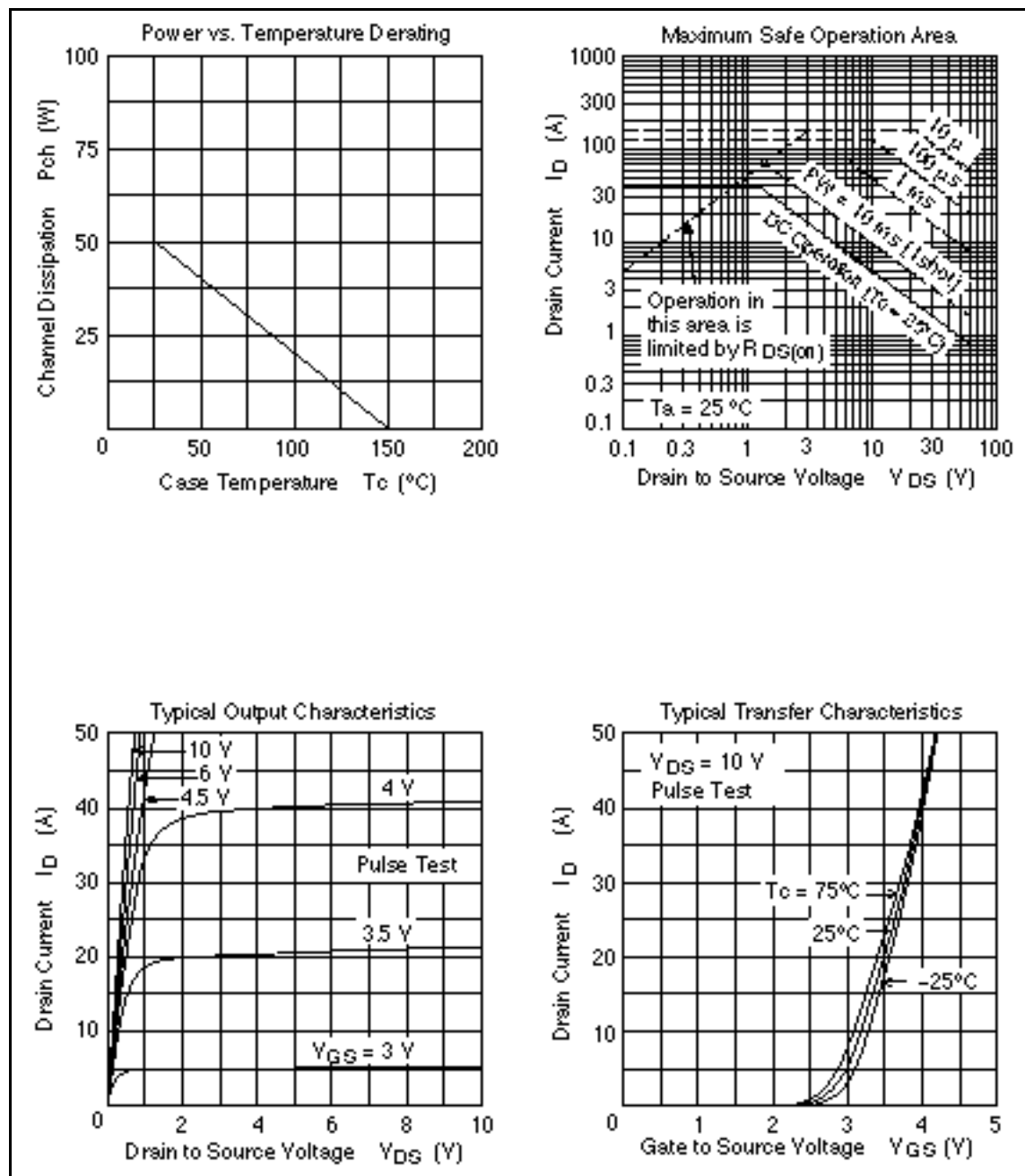
### Electrical Characteristics (Ta = 25°C)

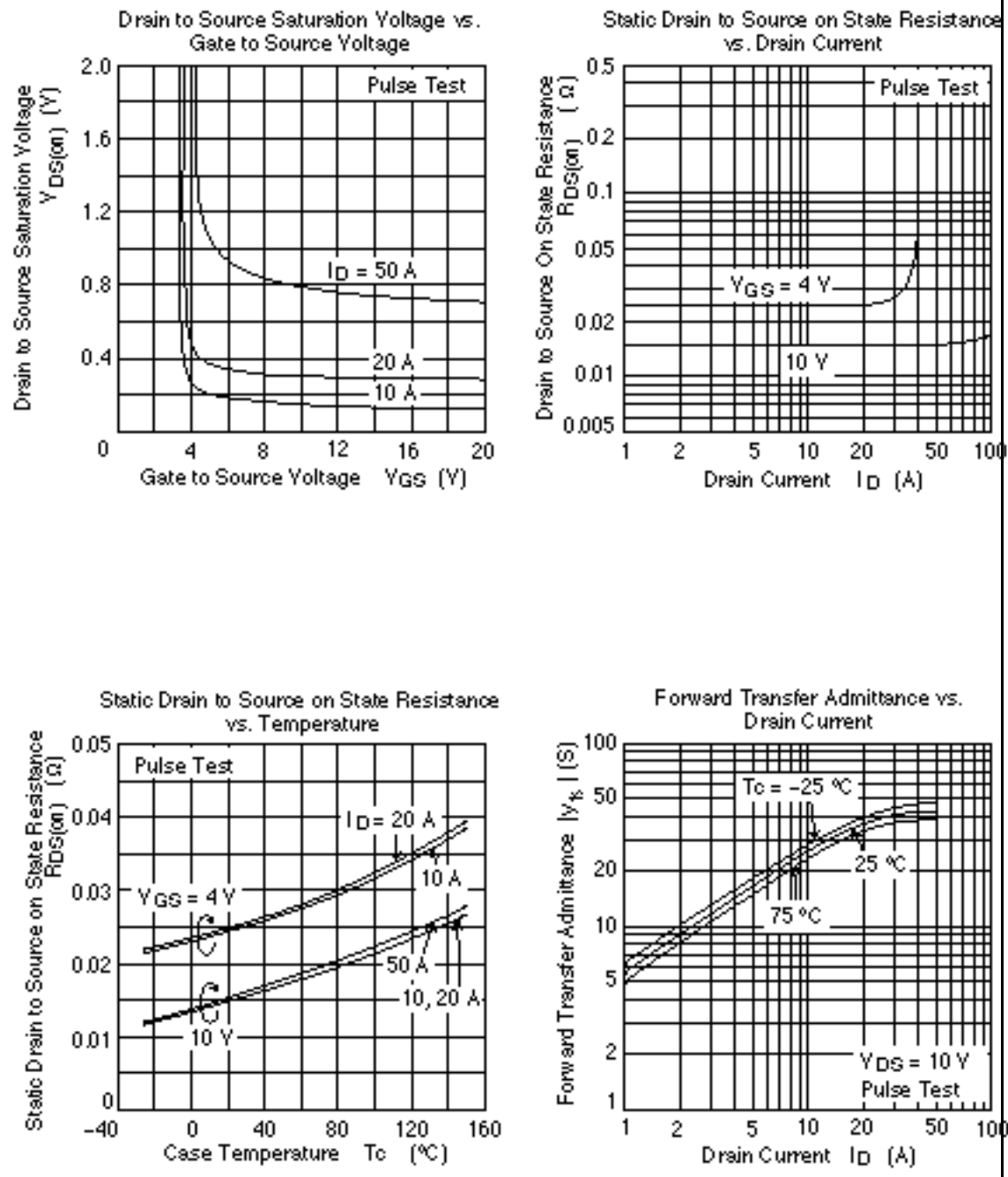
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10\text{mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	$\pm 20$	—	—	V	$I_G = \pm 100\mu\text{A}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 10$	$\mu\text{A}$	$V_{GS} = \pm 16\text{V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	10	$\mu\text{A}$	$V_{DS} = 60\text{V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.5	—	2.5	V	$I_D = 1\text{mA}$ , $V_{DS} = 10\text{V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	15	20	m	$I_D = 20\text{A}$ , $V_{GS} = 10\text{V}^{*1}$
	$R_{DS(on)}$	—	25	40	m	$I_D = 20\text{A}$ , $V_{GS} = 4\text{V}^{*1}$
Forward transfer admittance	$ y_{fs} $	20	35	—	S	$I_D = 20\text{A}$ , $V_{DS} = 10\text{V}^{*1}$
Input capacitance	$C_{iss}$	—	1500	—	pF	$V_{DS} = 10\text{V}$
Output capacitance	$C_{oss}$	—	720	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	$C_{rss}$	—	200	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$I_D = 20\text{A}$ , $V_{GS} = 10\text{V}$
Rise time	$t_r$	—	180	—	ns	$R_L = 1.5$
Turn-off delay time	$t_{d(off)}$	—	200	—	ns	
Fall time	$t_f$	—	200	—	ns	
Body to drain diode forward voltage	$V_{DF}$	—	0.95	—	V	$I_F = 40\text{A}$ , $V_{GS} = 0$ $diF/dt = 50\text{A}/\mu\text{s}$
Body to drain diode reverse recovery time	$t_{rr}$	—	70	—	V	$I_F = 40\text{A}$ , $V_{GS} = 0$ $diF/dt = 50\text{A}/\mu\text{s}$

Note: 1. Pulse test

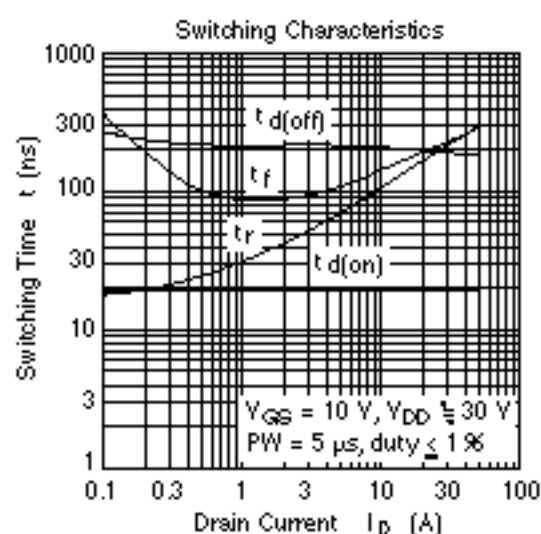
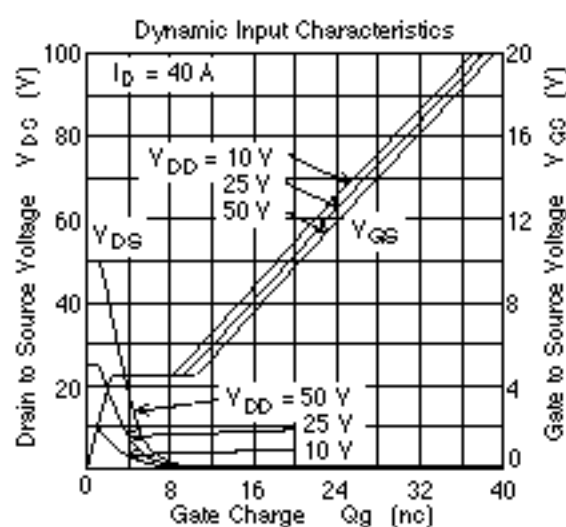
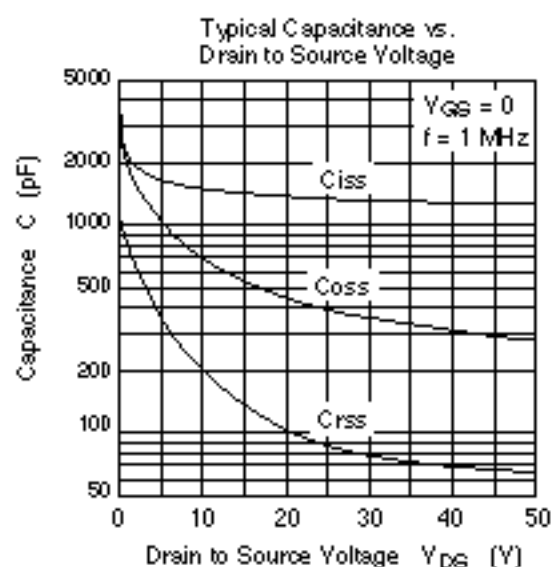
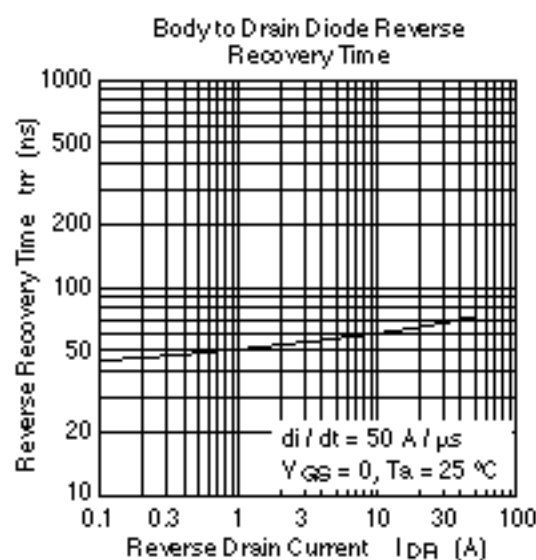
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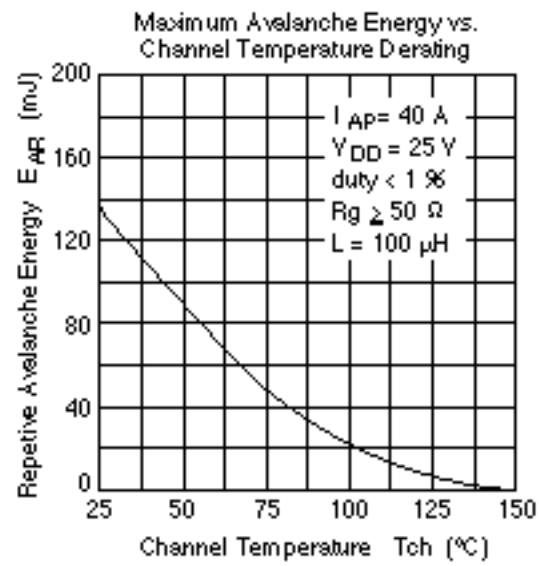
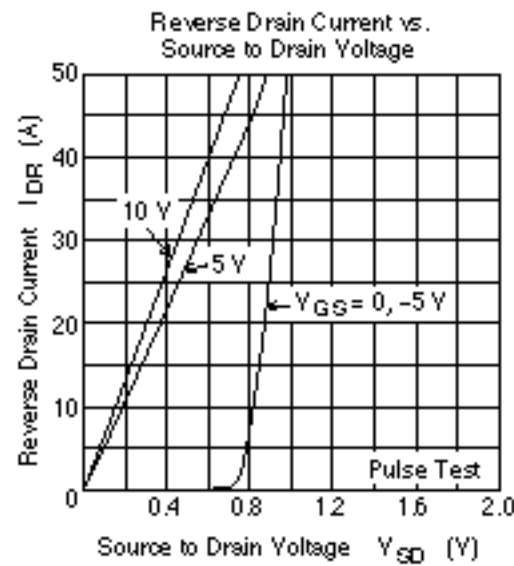
### Main Characteristics



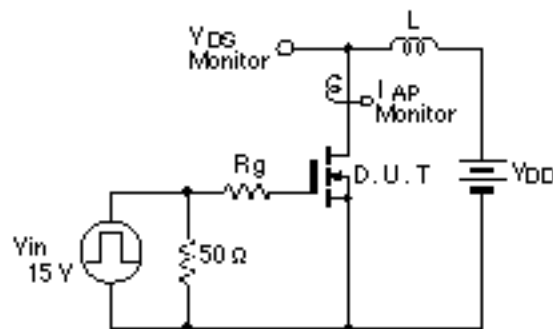


## 2SK2912(L), 2SK2912(S)



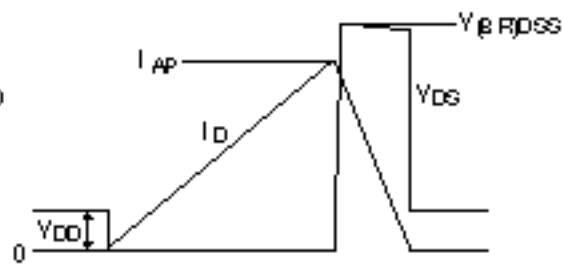


Avalanche Test Circuit

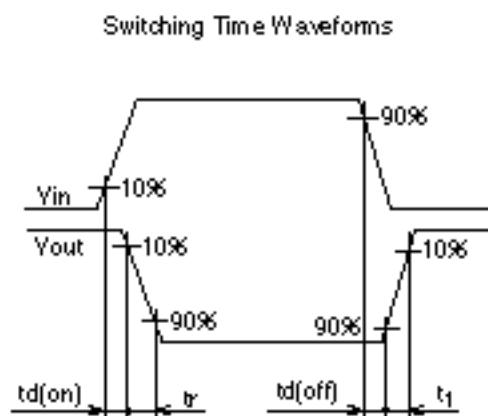
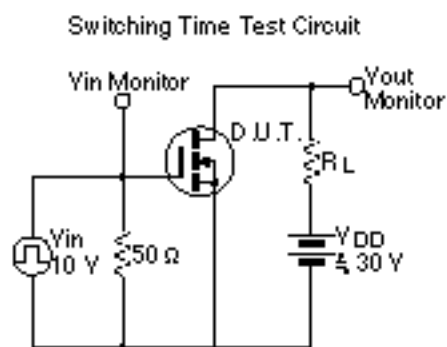
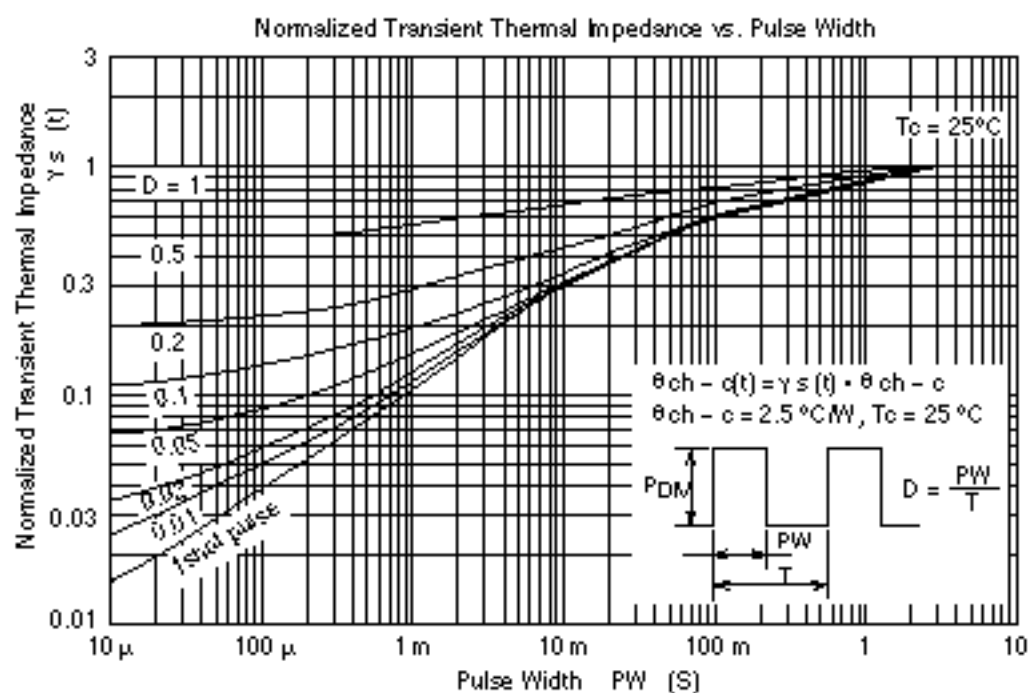


Avalanche Waveform

$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$



## 2SK2912(L), 2SK2912(S)

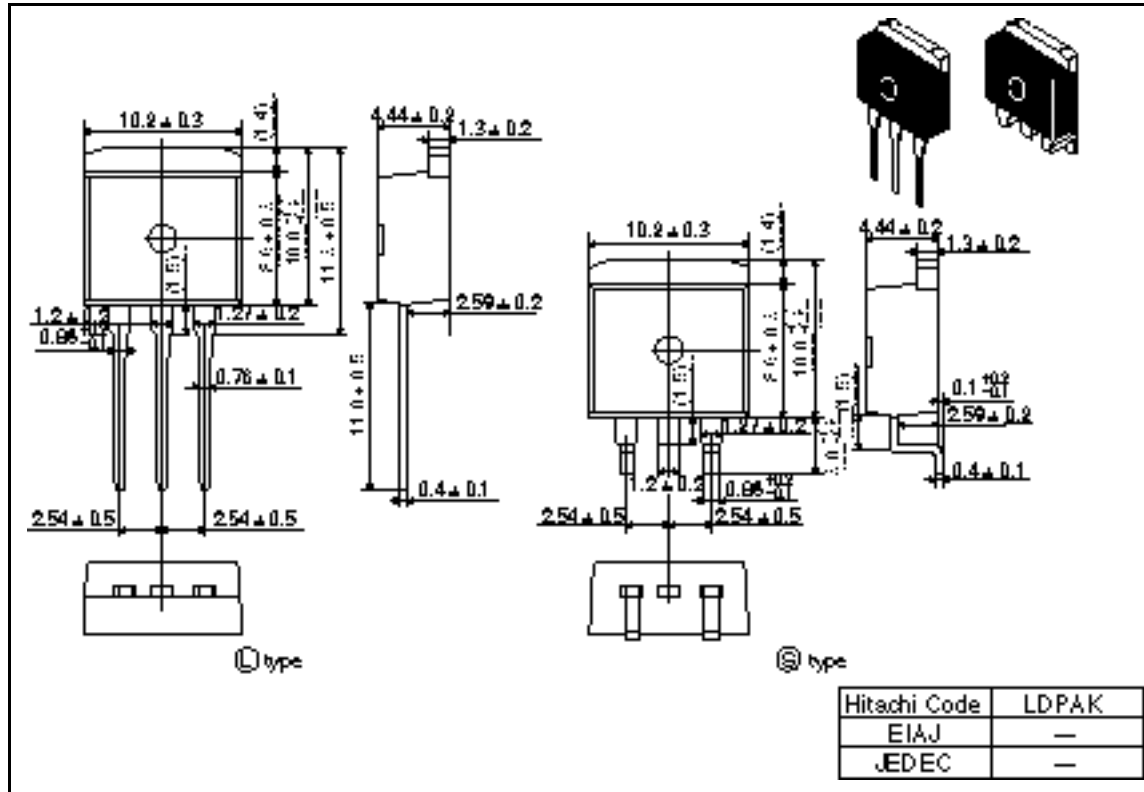




## 2SK2912(L), 2SK2912(S)

### Package Dimensions

Unit: mm



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## 2SK2912(L), 2SK2912(S)

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# HITACHI

### Hitachi, Ltd.

Semiconductor & IC Div.

Nippon Bldg., 2-6-2, Ohite-machi, Chiyoda-ku, Tokyo 100, Japan

Tel Tokyo (03) 3270-2111

Fax (03) 3270-5109

For further information write to:

Hitachi America, Ltd.

Semiconductor & IC Div.

2000 Sierra Point Parkway

Brisbane, CA 94005-4835

U.S.A.

Tel 415-589-8000

Fax 415-589-4207

Hitachi Europe GmbH

Electronic Components Group

Continental Europe

Danrecher Straße 3

D-85622 Feldkirchen

München

Tel 089-9 94 80-0

Fax 089-9 29 30 00

Hitachi Europe Ltd.

Electronic Components Div.

Northern Europe Headquarters

Whitebrook Park

Lower Cookham Road

Maidenhead

Berkshire SL6 8YA

United Kingdom

Tel 0628-585000

Fax 0628-778322

Hitachi Asia Pte. Ltd.

45 Collyer Quay #20-00

Hitachi Tower

Singapore 0104

Tel 535-2100

Fax 535-1533

Hitachi Asia (Hong Kong) Ltd.

Unit 705, North Tower,

World Finance Centre

Harbour City, Canton Road

Tsim Sha Tsui, Kowloon

Hong Kong

Tel 27359218

Fax 27306074

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